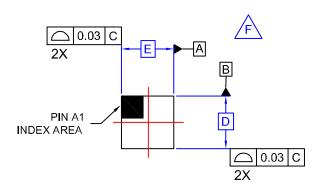
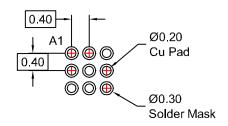


## WLCSP9 1.16x1.16x0.586 CASE 567RW ISSUE O

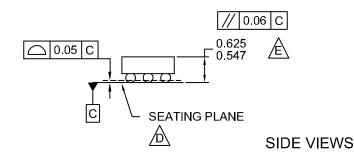
**DATE 30 NOV 2016** 

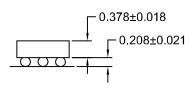


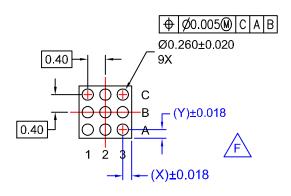


**TOP VIEW** 

LAND PATTERN RECOMMENDATION (NSMD PAD TYPE)







**BOTTOM VIEW** 

## NOTES:

- A. NO JEDEC REGISTRATION APPLIES.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCE PER ASMEY14.5M, 1994.

DATUM C IS DEFINED BY THE SPHERICAL CROWNS OF THE BALLS.

E PACKAGE NOMINAL HEIGHT IS 586 MICRONS ±39 MICRONS (547-625 MICRONS).

F.\ FOR DIMENSIONS D, E, X, AND Y SEE PRODUCT DATASHEET.

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DESCRIPTION:	WLCSP9 1.16x1.16x0.586		PAGE 1 OF 1

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